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CLAIMS

- 1. A process for producing a structure having holes, comprising steps of
- (A) providing an impressing member having protrusions, and a substrate,
 - (B) forming a layer, on the substrate, from a material having a less strength than the impressing member,
- (C) forming depressions by impressing the impressing 10 member on the layer corresponding to protrusions of the impressing member,
 - (D) etching the layer to bare at least a part of the surface of the substrate, and
- (E) anodizing the substrate to form holes on the substrate.
 - 2. The process according to claim 1, wherein the protrusions are formed in a regular pattern on the impressing member in the step (A).

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- 3. The process according to claim 1, wherein the etching in the step (D) is conducted by hydrolysis.
- 25 4. The process according to claim 1, wherein the layer formed in the step (B) contains an alkoxide.

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- 5. The process according to claim 1, wherein the step (D) and the step (E) are conducted concurrently.
- 6. The process according to claim 1, wherein the height of the protrusions is larger than the thickness of the layer formed from the material having a less strength than the impressing member in the Step (A).

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- 7. The process according to claim 1, wherein the step (D) comprises, after the step of baring the surface of the substrate, an additional step of forming a film from an electroconductive material insoluble in a solution employed in the anodization but is dissolved by the anodization.
- 8. A process for producing a functional structure comprising a step of filling a functional material into the holes formed in the process set forth in claim 1.
- The process for producing a functional structure according to claim 8, wherein the
 functional material is a magnetic material.